

IXFH16N60P3-VB Datasheet

N-Channel 650 V (D-S) Super Junction MOSFET

| PRODUCT SUMMARY | | | | |
|--|------------------------|------|--|--|
| V _{DS} (V) at T _J max. | 650 | | | |
| R _{DS(on)} (Ω) at 25 °C | V _{GS} = 10 V | 0.19 | | |
| Q _g max. (nC) | 106 | | | |
| Q _{gs} (nC) | 14 | | | |
| Q _{gd} (nC) | 33 | | | |
| Configuration | Single | | | |

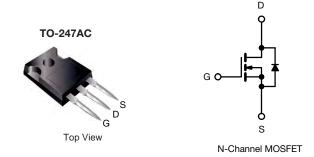
FEATURES

- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Low switching losses due to reduced Q_{rr}
- Ultra low gate charge (Qa)
- Avalanche energy rated (UIS)



APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
 - Battery chargers
- Renewable energy
 - Solar (PV inverters)
- Switch mode power supplies (SMPS)



| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | | |
|--|-------------------------|---|-----------------------------------|-------------|------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | | V_{DS} | 650 | V | |
| Gate-Source Voltage | | | V _{GS} | ± 30 | | |
| Continuous Drain Current (T _J = 150 °C) |)/ at 10.)/ | $T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$ | , | 20 | | |
| | V _{GS} at 10 V | T _C = 100 °C | I _D | 13 | Α | |
| Pulsed Drain Current ^a | | | I _{DM} | 53 | | |
| Linear Derating Factor | | | | 1.7 | W/°C | |
| Single Pulse Avalanche Energy b | | | E _{AS} | 367 | mJ | |
| Maximum Power Dissipation | | | P _D | 208 | W | |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | -55 to +150 | °C | |
| Drain-Source Voltage Slope | T _J = 125 °C | | 4).//d+ | 37 | V/ns | |
| Reverse Diode dV/dt ^d | dV/dt | | av/at | 31 | | |
| Soldering Recommendations (Peak Temperature) c | for 10 s | | | 300 | °C | |

- a. Repetitive rating; pulse width limited by maximum junction temperature. b. $V_{DD}=50$ V, starting $T_J=25$ °C, L=28.2 mH, $R_g=25$ Ω , $I_{AS}=5.1$ A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.

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| THERMAL RESISTANCE RATINGS | | | | | | |
|----------------------------------|-------------------|------|------|-------|--|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | | |
| Maximum Junction-to-Ambient | R _{thJA} | - | 62 | °C/W | | |
| Maximum Junction-to-Case (Drain) | R_{thJC} | - | 0.5 | C/ VV | | |

| PARAMETER | SYMBOL | TES | T CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|---|---|------|------|-------|------|
| Static | | • | | | | | • |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 650 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | e to 25 °C, I _D = 1 mA | - | 0.67 | - | V/°C |
| Gate-Source Threshold Voltage (N) | V _{GS(th)} | V _{DS} = | V _{DS} = V _{GS} , I _D = 250 μA | | - | 4 | ٧ |
| Gate-Source Leakage | I _{GSS} | V _{GS} = ± 20 V | | - | - | ± 100 | nA |
| | | | $V_{GS} = \pm 30 \text{ V}$ | - | - | ± 1 | μΑ |
| Zaus Osta Valtana Busin Commant | , | $V_{DS} = 520 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 520 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$ | | - | - | 1 | μА |
| Zero Gate Voltage Drain Current | I _{DSS} | | | - | - | 500 | |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 11 A | - | 0.19 | - | Ω |
| Forward Transconductance | 9 _{fs} | V _{DS} = 30 V, I _D = 11 A | | - | 7.0 | - | S |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | V _{GS} = 0 V, V _{DS} = 100 V, f = 1 MHz | | - | 2322 | - | pF |
| Output Capacitance | C _{oss} | | | - | 105 | - | |
| Reverse Transfer Capacitance | C _{rss} | | | - | 4 | - | |
| Effective Output Capacitance, Energy Related ^a | C _{o(er)} | - V _{DS} = 0 V to 520 V, V _{GS} = 0 V | | - | 84 | - | |
| Effective Output Capacitance, Time Related ^b | C _{o(tr)} | | | - | 293 | - | |
| Total Gate Charge | Qg | | | - | 71 | 106 | |
| Gate-Source Charge | Q _{gs} | $V_{GS} = 10 \text{ V}$ $I_{D} = 11 \text{ A}, V_{DS} = 520 \text{ V}$ | - | 14 | - | nC | |
| Gate-Drain Charge | Q _{gd} | 1 | | | 33 | | - |
| Turn-On Delay Time | t _{d(on)} | $V_{DD} = 520 \text{ V, } I_{D} = 11 \text{ A,}$ $V_{GS} = 10 \text{ V, } R_{g} = 9.1 \Omega$ | | - | 22 | 44 | ns |
| Rise Time | t _r | | | - | 34 | 68 | |
| Turn-Off Delay Time | t _{d(off)} | | | - | 68 | 102 | |
| Fall Time | t _f | | | - | 42 | 84 | |
| Gate Input Resistance | R _g | f = 1 MHz, open drain | | - | 0.78 | - | Ω |
| Drain-Source Body Diode Characteristic | S | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 21 | |
| Pulsed Diode Forward Current | I _{SM} | | | - | - | 53 | A |
| Diode Forward Voltage | V _{SD} | T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V | | - | 0.9 | 1.2 | V |
| Reverse Recovery Time | t _{rr} | $T_J = 25 \text{ °C}, I_F = I_S = 11 \text{ A},$ $dI/dt = 100 \text{ A/µs}, V_R = 25 \text{ V}$ | | - | 160 | - | ns |
| Reverse Recovery Charge | Q _{rr} | | | - | 1.2 | - | μC |
| Reverse Recovery Current | I _{RRM} | | | _ | 14 | _ | A |

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

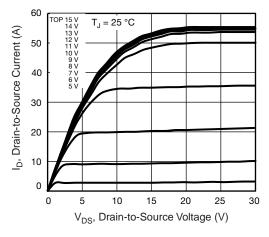


Fig. 1 - Typical Output Characteristics

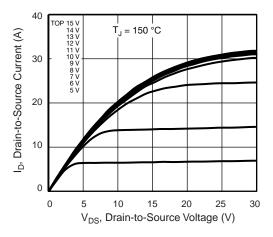


Fig. 2 - Typical Output Characteristics

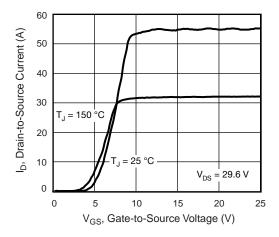


Fig. 3 - Typical Transfer Characteristics

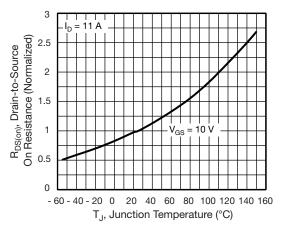


Fig. 4 - Normalized On-Resistance vs. Temperature

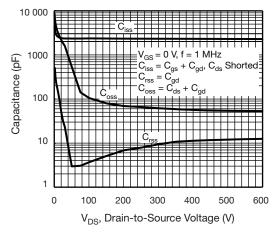


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

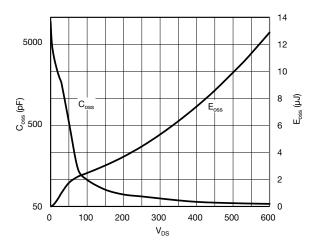


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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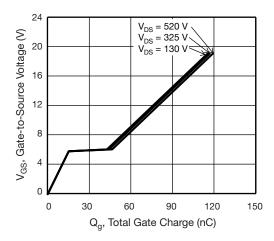


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

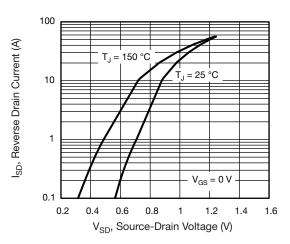


Fig. 8 - Typical Source-Drain Diode Forward Voltage

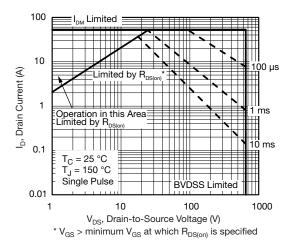


Fig. 9 - Maximum Safe Operating Area

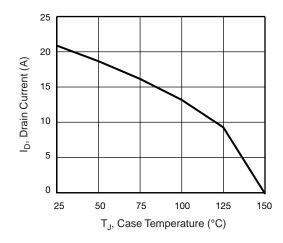


Fig. 10 - Maximum Drain Current vs. Case Temperature

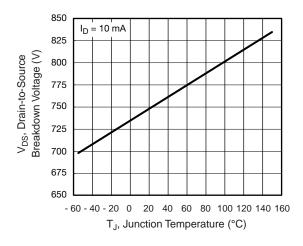


Fig. 11 - Temperature vs. Drain-to-Source Voltage



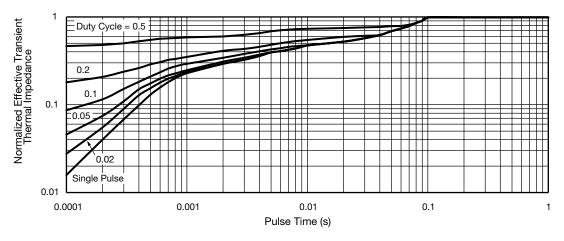


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

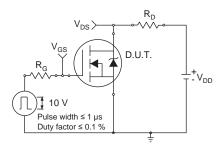


Fig. 13 - Switching Time Test Circuit

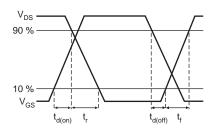


Fig. 14 - Switching Time Waveforms

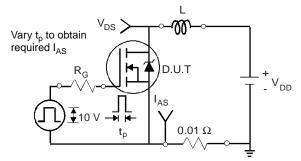


Fig. 15 - Unclamped Inductive Test Circuit

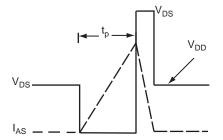


Fig. 16 - Unclamped Inductive Waveforms

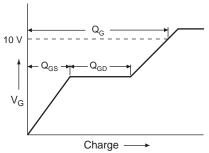


Fig. 17 - Basic Gate Charge Waveform

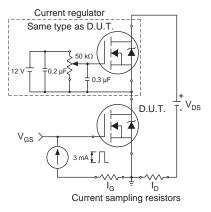
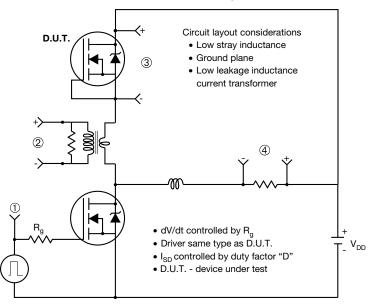


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



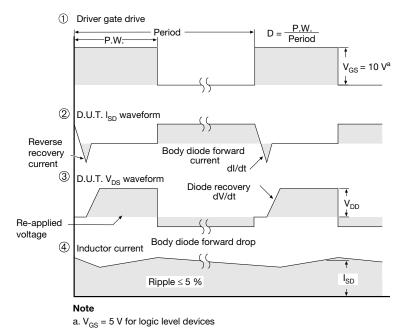


Fig. 19 - For N-Channel



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